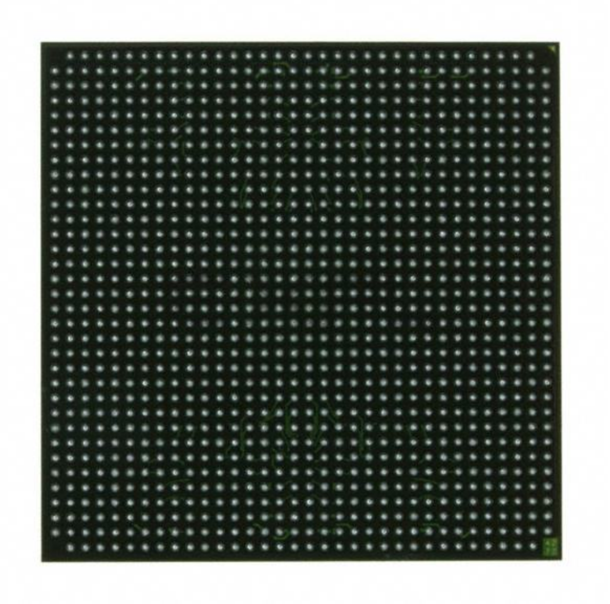

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details	
Product Status	Obsolete
Number of LABs/CLBs	11648
Number of Logic Elements/Cells	-
Total RAM Bits	3096576
Number of I/O	824
Number of Gates	8000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v8000-5ffg1152i

- HSTL (Class I, II, III, and IV)
- SSTL (3.3V and 2.5V, Class I and II)
- AGP-2X

The digitally controlled impedance (DCI) I/O feature automatically provides on-chip termination for each I/O element.

The IOB elements also support the following differential signaling I/O standards:

- LVDS
- BLVDS (Bus LVDS)
- ULVDS
- LDT
- LVPECL

Two adjacent pads are used for each differential pair. Two or four IOB blocks connect to one switch matrix to access the routing resources.

Configurable Logic Blocks (CLBs)

CLB resources include four slices and two 3-state buffers. Each slice is equivalent and contains:

- Two function generators (F & G)
- Two storage elements
- Arithmetic logic gates
- Large multiplexers
- Wide function capability
- Fast carry look-ahead chain
- Horizontal cascade chain (OR gate)

The function generators F & G are configurable as 4-input look-up tables (LUTs), as 16-bit shift registers, or as 16-bit distributed SelectRAM memory.

In addition, the two storage elements are either edge-triggered D-type flip-flops or level-sensitive latches.

Each CLB has internal fast interconnect and connects to a switch matrix to access general routing resources.

Block SelectRAM Memory

The block SelectRAM memory resources are 18 Kb of dual-port RAM, programmable from 16K x 1 bit to 512 x 36 bits, in various depth and width configurations. Each port is totally synchronous and independent, offering three "read-during-write" modes. Block SelectRAM memory is cascadable to implement large embedded storage blocks. Supported memory configurations for dual-port and single-port modes are shown in Table 3.

Table 3: **Dual-Port And Single-Port Configurations**

16K x 1 bit	2K x 9 bits
8K x 2 bits	1K x 18 bits
4K x 4 bits	512 x 36 bits

A multiplier block is associated with each SelectRAM memory block. The multiplier block is a dedicated 18 x 18-bit multiplier and is optimized for operations based on the block SelectRAM content on one port. The 18 x 18 multiplier can be used independently of the block SelectRAM resource. Read/multiply/accumulate operations and DSP filter structures are extremely efficient.

Both the SelectRAM memory and the multiplier resource are connected to four switch matrices to access the general routing resources.

Global Clocking

The DCM and global clock multiplexer buffers provide a complete solution for designing high-speed clocking schemes.

Up to 12 DCM blocks are available. To generate de-skewed internal or external clocks, each DCM can be used to eliminate clock distribution delay. The DCM also provides 90-, 180-, and 270-degree phase-shifted versions of its output clocks. Fine-grained phase shifting offers high-resolution phase adjustments in increments of 1/256 of the clock period. Very flexible frequency synthesis provides a clock output frequency equal to any M/D ratio of the input clock frequency, where M and D are two integers. For the exact timing parameters, see Virtex-II Electrical Characteristics.

Virtex-II devices have 16 global clock MUX buffers, with up to eight clock nets per quadrant. Each global clock MUX buffer can select one of the two clock inputs and switch glitch-free from one clock to the other. Each DCM block is able to drive up to four of the 16 global clock MUX buffers.

Routing Resources

The IOB, CLB, block SelectRAM, multiplier, and DCM elements all use the same interconnect scheme and the same access to the global routing matrix. Timing models are shared, greatly improving the predictability of the performance of high-speed designs.

There are a total of 16 global clock lines, with eight available per quadrant. In addition, 24 vertical and horizontal long lines per row or column as well as massive secondary and local routing resources provide fast interconnect. Virtex-II buffered interconnects are relatively unaffected by net fanout and the interconnect layout is designed to minimize crosstalk.

Horizontal and vertical routing resources for each row or column include:

- 24 long lines
- 120 hex lines
- 40 double lines
- 16 direct connect lines (total in all four directions)

Virtex-II Platform FPGAs: Functional Description

DS031-2 (v3.5) November 5, 2007

Product Specification

Detailed Description

Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in Figure 1.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.

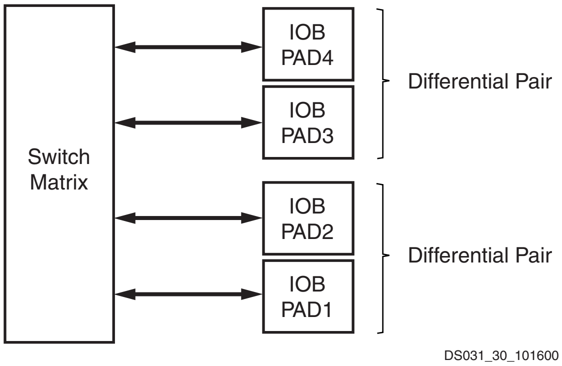


Figure 1: **Virtex-II Input/Output Tile**

Note: Differential I/Os must use the same clock.

Supported I/O Standards

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage (V_{CCINT} = 1.5V), output driver supply voltage (V_{CCO}) is dependent on the I/O standard (see Table 1 and Table 2). An auxiliary supply voltage (V_{CCAUX} = 3.3 V) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see DC Input and Output Levels in Module 3.

All of the user IOBs have fixed-clamp diodes to V_{CCO} and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the "5V Tolerant I/Os" Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See Digitally Controlled Impedance (DCI), page 8.

Table 1: **Supported Single-Ended I/O Standards**

IOSTANDARD Attribute	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Board Termination Voltage (V_{TT})
LVTTL	3.3	3.3	N/R(3)	N/R
LVCMOS33	3.3	3.3	N/R	N/R
LVCMOS25	2.5	2.5	N/R	N/R
LVCMOS18	1.8	1.8	N/R	N/R
LVCMOS15	1.5	1.5	N/R	N/R
PCI33_3	3.3	3.3	N/R	N/R
PCI66_3	3.3	3.3	N/R	N/R
PCI-X	3.3	3.3	N/R	N/R
GTL	Note (1)	Note (1)	0.8	1.2
GTLP	Note (1)	Note (1)	1.0	1.5
HSTL_I	1.5	N/R	0.75	0.75
HSTL_II	1.5	N/R	0.75	0.75
HSTL_III	1.5	N/R	0.9	1.5
HSTL_IV	1.5	N/R	0.9	1.5
HSTL_I_18	1.8	N/R	0.9	0.9
HSTL_II_18	1.8	N/R	0.9	0.9
HSTL_III _18	1.8	N/R	1.1	1.8
HSTL_IV_18	1.8	N/R	1.1	1.8
SSTL18_I(2)	1.8	N/R	0.9	0.9
SSTL18_II	1.8	N/R	0.9	0.9
SSTL2_I	2.5	N/R	1.25	1.25
SSTL2_II	2.5	N/R	1.25	1.25
SSTL3_I	3.3	N/R	1.5	1.5
SSTL3_II	3.3	N/R	1.5	1.5
AGP-2X/AGP	3.3	N/R	1.32	N/R

Notes:

1. V_{CCO} of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect V_{CCO} to 1.5V.
2. SSTL18_I is not a JEDEC-supported standard.
3. N/R = no requirement.

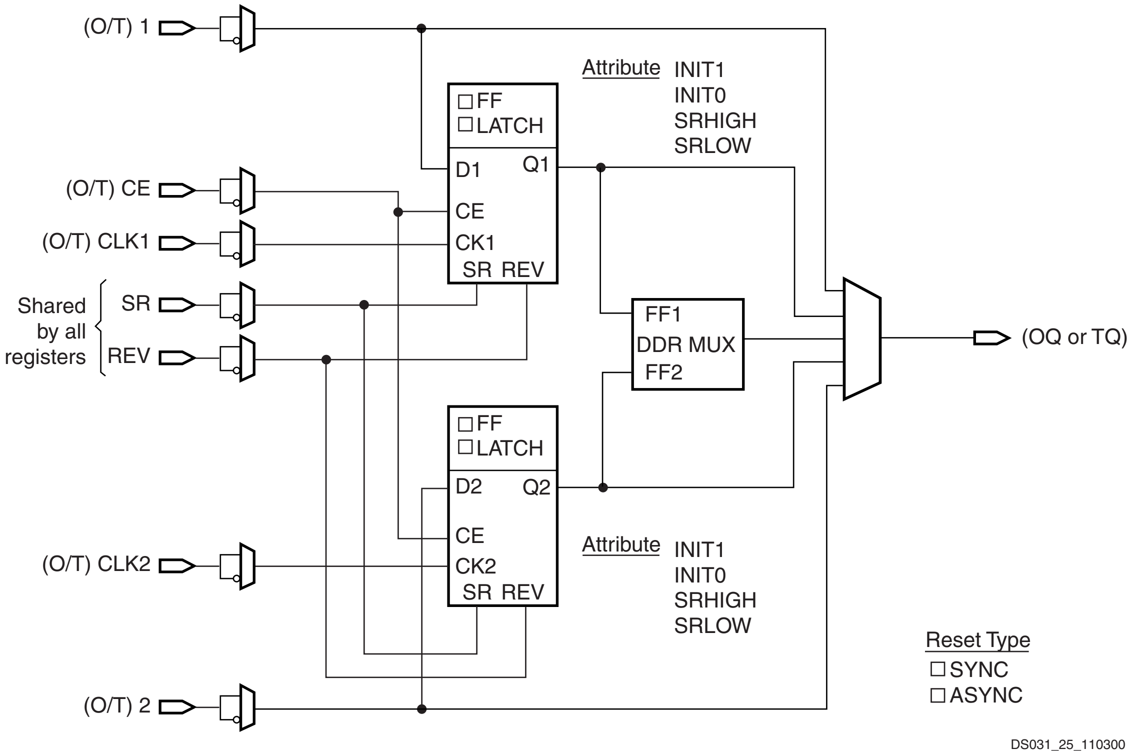


Figure 4: **Register / Latch Configuration in an IOB Block**

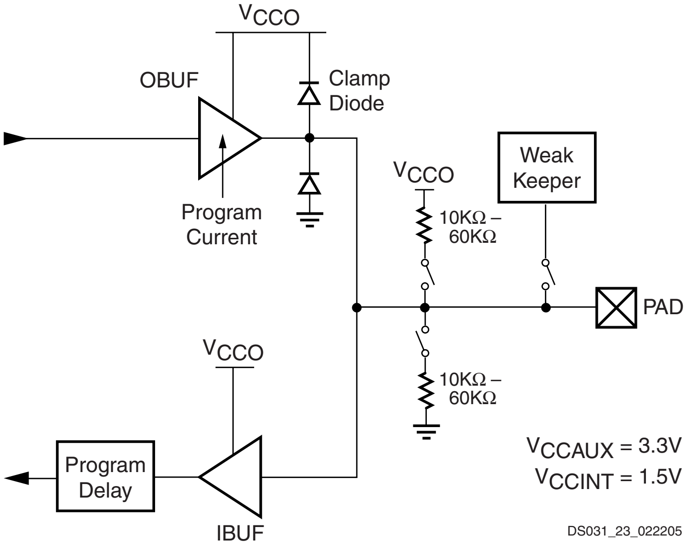


Figure 5: **LVTTL, LVCMOS or PCI SelectI/O-Ultra Standards**

Input/Output Individual Options

Each device pad has optional pull-up and pull-down in all SelectI/O-Ultra configurations. Each device pad has optional weak-keeper in LVTTL, LVCMOS, and PCI SelectI/O-Ultra configurations, as illustrated in Figure 5. Values of the optional pull-up and pull-down resistors are in the range 10 - 60 KΩ, which is the specification for V_{CCO} when operating at 3.3V (from 3.0 to 3.6V only). The clamp diode is always present, even when power is not.

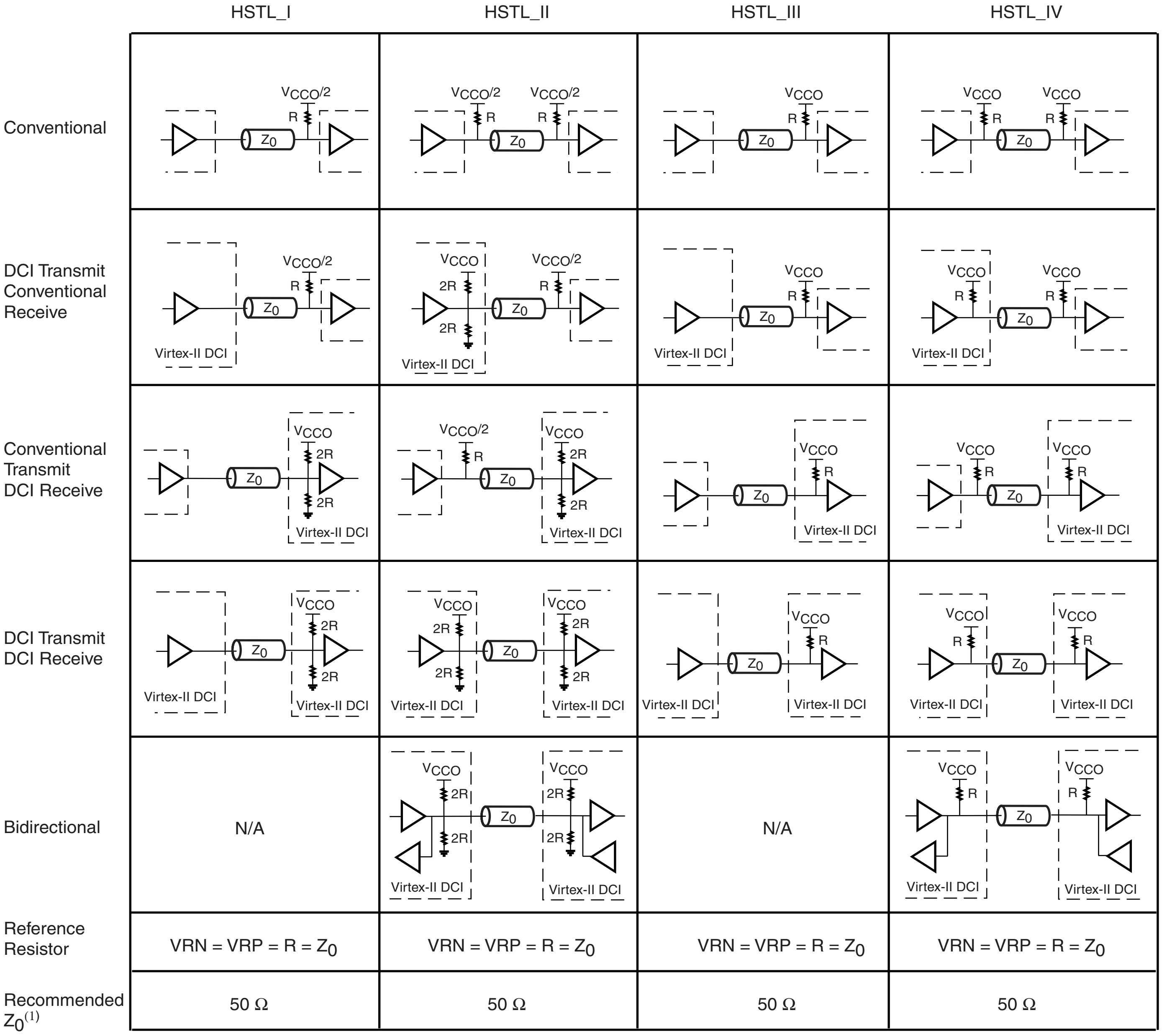
The optional weak-keeper circuit is connected to each user I/O pad. When selected, the circuit monitors the voltage on the pad and weakly drives the pin High or Low. If the pin is connected to a multiple-source signal, the weak-keeper holds the signal in its last state if all drivers are disabled. Maintaining a valid logic level in this way eliminates bus chatter. An enabled pull-up or pull-down overrides the weak-keeper circuit.

LVTTL sinks and sources current up to 24 mA. The current is programmable for LVTTL and LVCMOS SelectI/O-Ultra standards (see Table 4). Drive-strength and slew-rate controls for each output driver, minimize bus transients. For LVDCI and LVDCI_DV2 standards, drive strength and slew-rate controls are not available.

Table 8: **SelectI/O-Ultra Differential Buffers With On-Chip Termination**

I/O Standard Description	IOSTANDARD Attribute	
	External Termination	**On-Chip Termination**
LVDS 2.5V	LVDS_25	LVDS_25_DCI
LVDS Extended 2.5V	LVDSEXT_25	LVDSEXT_25_DCI

Figure 11 provides examples illustrating the use of the HSTL_I_DCI, HSTL_II_DCI, HSTL_III_DCI, and HSTL_IV_DCI I/O standards. For a complete list, see the **Virtex-II Platform FPGA User Guide**.



Note:
1. Z_0 is the recommended PCB trace impedance.

Figure 11: **HSTL DCI Usage Examples**

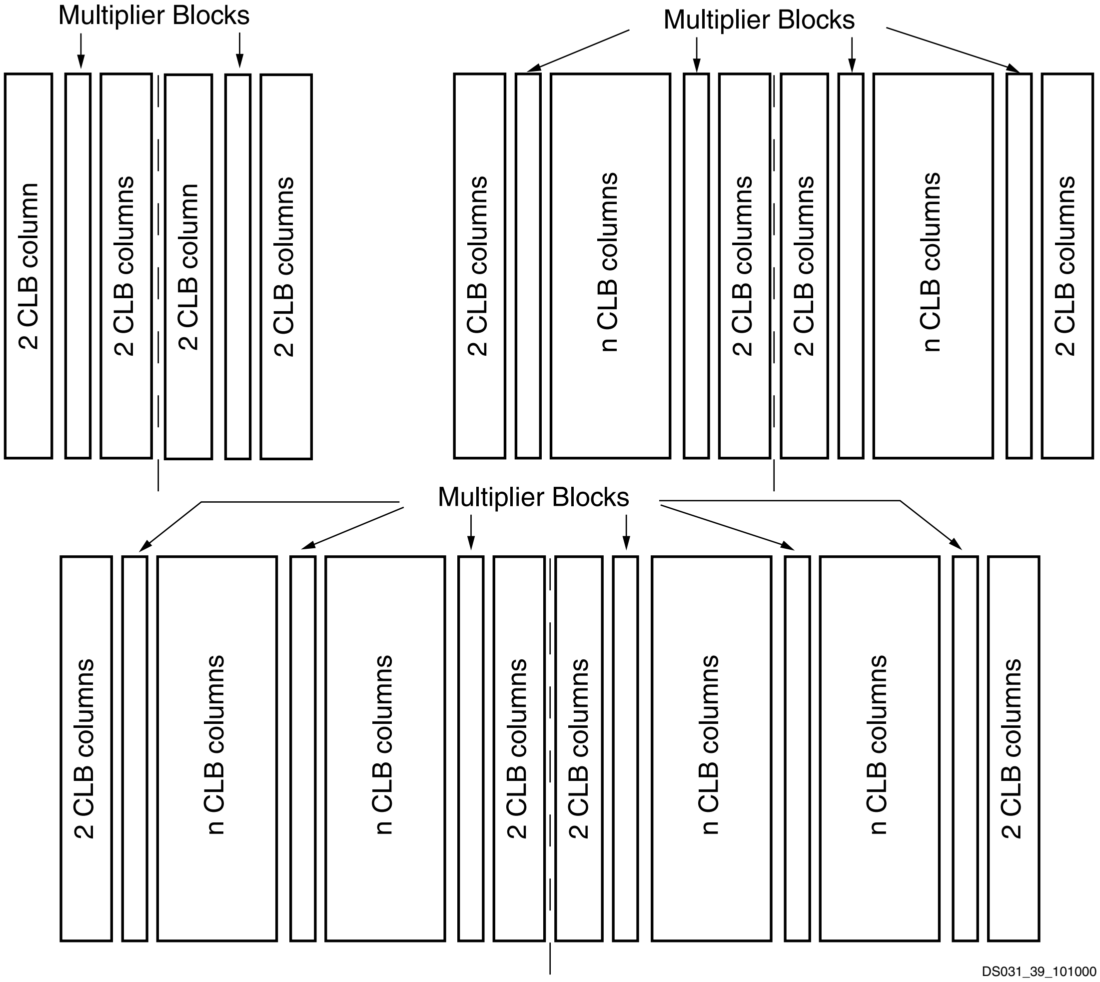


Figure 37: **Multipliers (2-column, 4-column, and 6-column)**

Global Clock Multiplexer Buffers

Virtex-II devices have 16 clock input pins that can also be used as regular user I/Os. Eight clock pads are on the top edge of the device, in the middle of the array, and eight are on the bottom edge, as illustrated in Figure 38.

The global clock multiplexer buffer represents the input to dedicated low-skew clock tree distribution in Virtex-II devices. Like the clock pads, eight global clock multiplexer buffers are on the top edge of the device and eight are on the bottom edge.

Each global clock buffer can either be driven by the clock pad to distribute a clock directly to the device, or driven by the Digital Clock Manager (DCM), discussed in Digital Clock Manager (DCM), page 29. Each global clock buffer can also be driven by local interconnects. The DCM has clock output(s) that can be connected to global clock buffer inputs, as shown in Figure 39.

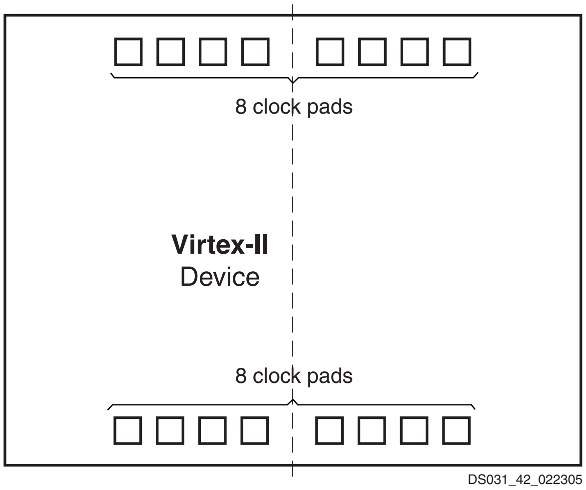


Figure 38: **Virtex-II Clock Pads**

Date	Version	Revision
07/16/02	2.0	- Updated compatible input standards listed in Table 6.
09/26/02	2.1	- Changed number of resources available to the XC2V40 device in Table 13. - Clarified Power On Reset information under Configuration Sequence.
12/06/02	2.1.1	- Cosmetic edits.
05/07/03	2.1.2	- Added qualification note to Figure 13, page 11. - Corrected sentence in section Input/Output Individual Options, page 4, to read “The optional weak-keeper circuit is connected to each *user I/O pad*.” - Corrected typographical errors in Table 3 for names of HSTL_[x]_DCI_18 standards.
06/19/03	2.2	- Removed Compatible Output Standards and Compatible Input Standards tables. - Added new Table 5, Summary of Voltage Supply Requirements for All Input and Output Standards. This table replaces deleted I/O standards tables. - Added section Rules for Combining I/O Standards in the Same Bank, page 6.
08/01/03	3.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.

10/14/03	3.1	- Added section Local Clocking, page 29.
		- Table 1, page 1:
		  - Added SSTL18_I and SSTL18_II.
		  - Corrected names of 1.8V HSTL_I-IV standards to “HSTL_I-IV_18”.
		  - Corrected Input V_{REF} for HSTL_III-IV_18 from 1.08V to 1.1V.
		  - Changed “N/A” to “N/R” (no requirement).
		- Table 2, page 2:
		  - Changed “N/A” to “N/R” (no requirement).
		- Table 3, page 2:
		  - Added SSTL18_I_DCI, SSTL18_II_DCI, LVDS_33_DCI, LVDSEXT_33_DCI, LVDS_25_DCI, and LVDSEXT_25_DCI.
		  - Corrected Input V_{REF} for HSTL_III-IV_18 from 1.08V to 1.1V.
		- Sections Slave-Serial Mode and Master-Serial Mode, page 36: Changed "rising" to "falling" edge with respect to DOUT.
		- Added verbiage to section Bitstream Encryption, page 38: “For devices that support this feature, please contact your sales representative for specific ordering part number.”

03/29/04	3.2	- Table 2, page 2, and Table 5, page 7: Removed LVDS_33_DCI and LVDSEXT_33_DCI from tables. - Table 26, page 37: Updated bitstream lengths. - Section BUFGMUX, page 29: Corrected the definition of the "presently selected clock" to be I0 or I1. Corrected signal names in Figure 44 and associated text from CLK0 and CLK1 to I0 and I1. - Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	- Table 1, page 1: Added example to Footnote (1) regarding V_{CCO} rules for GTL and GTLP. - Added reference to Pb-free package types in Figure 7, page 6.
03/01/05	3.4	- Reassigned heading hierarchies for better agreement with content. - Table 2: Corrected V_{OD} output voltages. - Table 26: Updated bitstream lengths.
11/05/07	3.5	- Updated copyright statement and legal disclaimer. - Boundary-Scan (JTAG, IEEE 1532) Mode, page 37: Updated IEEE 1149.1 compliance statement.

Table 14: **IOB Input Switching Characteristics** ***(Continued)***

			Speed Grade			
Description	**Symbol**	**Device**	**-6**	**-5**	**-4**	**Units**
Propagation Delays						
Pad to output IQ via transparent latch, no delay	T_{IOPLI}	All	0.83	0.91	1.05	ns, Max
Pad to output IQ via transparent latch, with delay	T_{IOPLID}	XC2V40	3.23	3.55	4.09	ns, Max
		XC2V80	3.23	3.55	4.09	ns, Max
		XC2V250	3.23	3.55	4.09	ns, Max
		XC2V500	3.23	3.55	4.09	ns, Max
		XC2V1000	3.23	3.55	4.09	ns, Max
		XC2V1500	3.23	3.55	4.09	ns, Max
		XC2V2000	3.23	3.55	4.09	ns, Max
		XC2V3000	3.32	3.65	4.20	ns, Max
		XC2V4000	3.32	3.65	4.20	ns, Max
		XC2V6000	3.60	3.95	4.55	ns, Max
		XC2V8000		3.95	4.55	ns, Max
Clock CLK to output IQ	T_{IOCKIQ}	All		0.67	0.77	ns, Max
Setup and Hold Times With Respect to Clock at IOB Input Register						
Pad, no delay	T_{IOPICK}/T_{IOICKP}	All	0.84/–0.36	0.92/–0.39	1.06/–0.45	ns, Min
Pad, with delay	$T_{IOPICKD}/T_{IOICKPD}$	XC2V40	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V80	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V250	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V500	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V1000	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V1500	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V2000	3.24/–2.04	3.57/–2.24	4.10/–2.58	ns, Min
		XC2V3000	3.33/–2.10	3.67/–2.31	4.22/–2.66	ns, Min
		XC2V4000	3.33/–2.10	3.67/–2.31	4.22/–2.66	ns, Min
		XC2V6000	3.61/–2.29	3.97/–2.52	4.56/–2.90	ns, Min
		XC2V8000		3.97/–2.52	4.56/–2.90	ns, Min
ICE input	$T_{IOICECK}/T_{IOCKICE}$	All		0.21/ 0.04	0.24/ 0.04	ns, Min
SR input (IFF, synchronous)	$T_{IOSRCKI}$	All	0.27	0.30	0.34	ns, Min
Set/Reset Delays						
SR input to IQ (asynchronous)	T_{IOSRIQ}	All	1.11	1.22	1.40	ns, Max
GSR to output IQ	T_{GSRQ}	All	5.44	5.98	6.88	ns, Max

Notes:

1. Input timing for LVTTL is measured at 1.4 V. For other I/O standards, see Table 18.

FG256/FGG256 Fine-Pitch BGA Package

As shown in Table 6, XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000 Virtex-II devices are available in the FG256/FGG256 fine-pitch BGA package. The pins in the XC2V250, XC2V500, and XC2V1000 devices are same. The No Connect columns show pin differences for the XC2V40 and XC2V80 devices. Following this table are the FG256/FGG256 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
0	IO_L01N_0	C4		
0	IO_L01P_0	B4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	B5		
0	IO_L03P_0/VRN_0	A5		
0	IO_L04N_0/VREF_0	D6	NC	NC
0	IO_L04P_0	C6	NC	NC
0	IO_L05N_0	B6	NC	NC
0	IO_L05P_0	A6	NC	NC
0	IO_L92N_0	E6	NC	NC
0	IO_L92P_0	E7	NC	NC
0	IO_L93N_0	D7	NC	NC
0	IO_L93P_0	C7	NC	NC
0	IO_L94N_0/VREF_0	B7		
0	IO_L94P_0	A7		
0	IO_L95N_0/GCLK7P	D8		
0	IO_L95P_0/GCLK6S	C8		
0	IO_L96N_0/GCLK5P	B8		
0	IO_L96P_0/GCLK4S	A8		
1	IO_L96N_1/GCLK3P	A9		
1	IO_L96P_1/GCLK2S	B9		
1	IO_L95N_1/GCLK1P	C9		
1	IO_L95P_1/GCLK0S	D9		
1	IO_L94N_1	A10		
1	IO_L94P_1/VREF_1	B10		
1	IO_L93N_1	C10	NC	NC
1	IO_L93P_1	D10	NC	NC
1	IO_L92N_1	E10	NC	NC

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
7	IO_L45N_7	F5	NC	NC
7	IO_L43P_7	F1	NC	NC
7	IO_L43N_7	F2	NC	NC
7	IO_L06P_7	F3	NC	
7	IO_L06N_7	F4	NC	
7	IO_L04P_7	E1	NC	
7	IO_L04N_7	E2	NC	
7	IO_L03P_7/VREF_7	E3		
7	IO_L03N_7	E4		
7	IO_L02P_7/VRN_7	D2		
7	IO_L02N_7/VRP_7	D3		
7	IO_L01P_7	D1		
7	IO_L01N_7	C1		
0	VCCO_0	F8		
0	VCCO_0	F7		
0	VCCO_0	E8		
1	VCCO_1	F10		
1	VCCO_1	F9		
1	VCCO_1	E9		
2	VCCO_2	H12		
2	VCCO_2	H11		
2	VCCO_2	G11		
3	VCCO_3	K11		
3	VCCO_3	J12		
3	VCCO_3	J11		
4	VCCO_4	M9		
4	VCCO_4	L10		
4	VCCO_4	L9		
5	VCCO_5	M8		
5	VCCO_5	L8		
5	VCCO_5	L7		
6	VCCO_6	K6		
6	VCCO_6	J6		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L69P_0/VREF_0	B9	NC	
0	IO_L70N_0	F10	NC	
0	IO_L70P_0	E10	NC	
0	IO_L72N_0	A10	NC	
0	IO_L72P_0	A11	NC	
0	IO_L73N_0	C10	NC	NC
0	IO_L73P_0	B10	NC	NC
0	IO_L91N_0/VREF_0	D11		
0	IO_L91P_0	C11		
0	IO_L92N_0	G11		
0	IO_L92P_0	E11		
0	IO_L93N_0	C12		
0	IO_L93P_0	B12		
0	IO_L94N_0/VREF_0	E12		
0	IO_L94P_0	D12		
0	IO_L95N_0/GCLK7P	G12		
0	IO_L95P_0/GCLK6S	F12		
0	IO_L96N_0/GCLK5P	H11		
0	IO_L96P_0/GCLK4S	H12		
1	IO_L96N_1/GCLK3P	A13		
1	IO_L96P_1/GCLK2S	A14		
1	IO_L95N_1/GCLK1P	B13		
1	IO_L95P_1/GCLK0S	C13		
1	IO_L94N_1	D13		
1	IO_L94P_1/VREF_1	E13		
1	IO_L93N_1	F13		
1	IO_L93P_1	G13		
1	IO_L92N_1	H13		
1	IO_L92P_1	H14		
1	IO_L91N_1	C14		
1	IO_L91P_1/VREF_1	D14		
1	IO_L73N_1	E14	NC	NC
1	IO_L73P_1	G14	NC	NC
1	IO_L72N_1	A15	NC	
1	IO_L72P_1	A16	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
2	IO_L01P_2	D23		
2	IO_L02N_2/VRP_2	E21		
2	IO_L02P_2/VRN_2	E22		
2	IO_L03N_2	F21		
2	IO_L03P_2/VREF_2	F20		
2	IO_L04N_2	G20		
2	IO_L04P_2	G19		
2	IO_L06N_2	H18		
2	IO_L06P_2	J17		
2	IO_L19N_2	D24		
2	IO_L19P_2	E23		
2	IO_L21N_2	E24		
2	IO_L21P_2/VREF_2	F24		
2	IO_L22N_2	F23		
2	IO_L22P_2	G23		
2	IO_L24N_2	G21		
2	IO_L24P_2	G22		
2	IO_L43N_2	H19		
2	IO_L43P_2	H20		
2	IO_L45N_2	J18		
2	IO_L45P_2/VREF_2	J19		
2	IO_L46N_2	K17		
2	IO_L46P_2	K18		
2	IO_L48N_2	H23		
2	IO_L48P_2	H24		
2	IO_L49N_2	H21		
2	IO_L49P_2	H22		
2	IO_L51N_2	J24		
2	IO_L51P_2/VREF_2	K24		
2	IO_L52N_2	J22		
2	IO_L52P_2	J23		
2	IO_L54N_2	J20		
2	IO_L54P_2	J21		
2	IO_L67N_2	K19	NC	
2	IO_L67P_2	K20	NC	
2	IO_L69N_2	L17	NC	

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
3	IO_L72N_3	T20
3	IO_L72P_3	T19
3	IO_L70N_3	U27
3	IO_L70P_3	U26
3	IO_L69N_3/VREF_3	U25
3	IO_L69P_3	V25
3	IO_L67N_3	U21
3	IO_L67P_3	U20
3	IO_L54N_3	V27
3	IO_L54P_3	V26
3	IO_L52N_3	V24
3	IO_L52P_3	V23
3	IO_L51N_3/VREF_3	V22
3	IO_L51P_3	W22
3	IO_L49N_3	V21
3	IO_L49P_3	V20
3	IO_L48N_3	W27
3	IO_L48P_3	Y27
3	IO_L46N_3	W26
3	IO_L46P_3	W25
3	IO_L45N_3/VREF_3	W24
3	IO_L45P_3	W23
3	IO_L43N_3	W21
3	IO_L43P_3	W20
3	IO_L28N_3	W19
3	IO_L28P_3	Y19
3	IO_L27N_3/VREF_3	Y25
3	IO_L27P_3	Y24
3	IO_L25N_3	Y23
3	IO_L25P_3	AA23
3	IO_L24N_3	Y22
3	IO_L24P_3	Y21
3	IO_L22N_3	AA27
3	IO_L22P_3	AB27
3	IO_L21N_3/VREF_3	AA26
3	IO_L21P_3	AA25

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
4	IO_L27P_4/VREF_4	AG19
4	IO_L28N_4	AB19
4	IO_L28P_4	AA19
4	IO_L30N_4	AC19
4	IO_L30P_4	AD19
4	IO_L49N_4	AE19
4	IO_L49P_4	AF19
4	IO_L51N_4	AA18
4	IO_L51P_4/VREF_4	Y18
4	IO_L52N_4	AB18
4	IO_L52P_4	AC18
4	IO_L54N_4	AD18
4	IO_L54P_4	AE18
4	IO_L67N_4	AF18
4	IO_L67P_4	AG18
4	IO_L69N_4	AA17
4	IO_L69P_4/VREF_4	Y17
4	IO_L70N_4	AB17
4	IO_L70P_4	AB16
4	IO_L72N_4	AD17
4	IO_L72P_4	AE17
4	IO_L73N_4	AF17
4	IO_L73P_4	AG17
4	IO_L75N_4	Y16
4	IO_L75P_4/VREF_4	W16
4	IO_L76N_4	AC16
4	IO_L76P_4	AD16
4	IO_L78N_4	AF16
4	IO_L78P_4	AG16
4	IO_L91N_4/VREF_4	W15
4	IO_L91P_4	Y15
4	IO_L92N_4	AB15
4	IO_L92P_4	AA15
4	IO_L93N_4	AC15
4	IO_L93P_4	AD15
4	IO_L94N_4/VREF_4	AE15

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
6	VCCO_6	V9
6	VCCO_6	U10
6	VCCO_6	U9
6	VCCO_6	T10
6	VCCO_6	T7
6	VCCO_6	T3
6	VCCO_6	R10
7	VCCO_7	M10
7	VCCO_7	M7
7	VCCO_7	M3
7	VCCO_7	L10
7	VCCO_7	L9
7	VCCO_7	K9
7	VCCO_7	G4
7	VCCO_7	N10
NA	CCLK	AA22
NA	PROG_B	C4
NA	DONE	AC22
NA	M0	AC6
NA	M1	Y7
NA	M2	AE4
NA	HSWAP_EN	D5
NA	TCK	G20
NA	TDI	H7
NA	TDO	G22
NA	TMS	F21
NA	PWRDWN_B	AE24
NA	DXN	G8
NA	DXP	F7
NA	VBATT	D23
NA	RSVD	C24
NA	VCCAUX	AF14
NA	VCCAUX	AE26
NA	VCCAUX	AE2

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
6	IO_L68N_6	Y26	NC	
6	IO_L69P_6	AA30	NC	
6	IO_L69N_6/VREF_6	Y30	NC	
6	IO_L70P_6	W24	NC	
6	IO_L70N_6	V24	NC	
6	IO_L71P_6	Y27	NC	
6	IO_L71N_6	W27	NC	
6	IO_L72P_6	W28	NC	
6	IO_L72N_6	Y28	NC	
6	IO_L73P_6	V25	NC	NC
6	IO_L73N_6	U25	NC	NC
6	IO_L74P_6	V26	NC	NC
6	IO_L74N_6	V27	NC	NC
6	IO_L75P_6	Y29	NC	NC
6	IO_L75N_6/VREF_6	W29	NC	NC
6	IO_L76P_6	U22	NC	NC
6	IO_L76N_6	T22	NC	NC
6	IO_L77P_6	U26	NC	NC
6	IO_L77N_6	T26	NC	NC
6	IO_L78P_6	V30	NC	NC
6	IO_L78N_6	W30	NC	NC
6	IO_L91P_6	U23		
6	IO_L91N_6	T23		
6	IO_L92P_6	U27		
6	IO_L92N_6	T27		
6	IO_L93P_6	V29		
6	IO_L93N_6/VREF_6	U29		
6	IO_L94P_6	T24		
6	IO_L94N_6	T25		
6	IO_L95P_6	U28		
6	IO_L95N_6	T28		
6	IO_L96P_6	T30		
6	IO_L96N_6	U30		
7	IO_L96P_7	P28		
7	IO_L96N_7	R28		
7	IO_L95P_7	R25		

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L52P_7	J29		
7	IO_L52N_7	K29		
7	IO_L51P_7/VREF_7	K27		
7	IO_L51N_7	J27		
7	IO_L50P_7	L24		
7	IO_L50N_7	K24		
7	IO_L49P_7	H27		
7	IO_L49N_7	J28		
7	IO_L48P_7	H26		
7	IO_L48N_7	J26		
7	IO_L47P_7	K25		
7	IO_L47N_7	J25		
7	IO_L46P_7	H28		
7	IO_L46N_7	H29		
7	IO_L45P_7/VREF_7	G28		
7	IO_L45N_7	F28		
7	IO_L44P_7	L23		
7	IO_L44N_7	K23		
7	IO_L43P_7	F30		
7	IO_L43N_7	G30		
7	IO_L24P_7	F26		
7	IO_L24N_7	G27		
7	IO_L23P_7	J24		
7	IO_L23N_7	H24		
7	IO_L22P_7	F29		
7	IO_L22N_7	G29		
7	IO_L21P_7/VREF_7	G26		
7	IO_L21N_7	G25		
7	IO_L20P_7	H25		
7	IO_L20N_7	G24		
7	IO_L19P_7	D30		
7	IO_L19N_7	E30		
7	IO_L06P_7	E27		
7	IO_L06N_7	F27		
7	IO_L05P_7	J23		
7	IO_L05N_7	H22		
7	IO_L04P_7	C29		

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
1	IO_L93P_1	F17	
1	IO_L92N_1	G16	
1	IO_L92P_1	G17	
1	IO_L91N_1	C16	
1	IO_L91P_1/VREF_1	C15	
1	IO_L84N_1	D14	NC
1	IO_L84P_1	D15	NC
1	IO_L83N_1	J17	NC
1	IO_L83P_1	K17	NC
1	IO_L82N_1	B17	NC
1	IO_L82P_1	A17	NC
1	IO_L81N_1/VREF_1	A15	NC
1	IO_L81P_1	B16	NC
1	IO_L80N_1	L17	NC
1	IO_L80P_1	L16	NC
1	IO_L79N_1	A13	NC
1	IO_L79P_1	A14	NC
1	IO_L78N_1	C13	
1	IO_L78P_1	C14	
1	IO_L77N_1	K16	
1	IO_L77P_1	K15	
1	IO_L76N_1	B13	
1	IO_L76P_1	B14	
1	IO_L75N_1/VREF_1	F15	
1	IO_L75P_1	G15	
1	IO_L74N_1	H15	
1	IO_L74P_1	H14	
1	IO_L73N_1	A11	
1	IO_L73P_1	A12	
1	IO_L72N_1	E13	
1	IO_L72P_1	E14	
1	IO_L71N_1	J15	
1	IO_L71P_1	J14	
1	IO_L70N_1	D12	
1	IO_L70P_1	D13	
1	IO_L69N_1/VREF_1	F14	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	IO_L51N_2	L6	
2	IO_L51P_2/VREF_2	M6	
2	IO_L52N_2	M3	
2	IO_L52P_2	L3	
2	IO_L53N_2	L4	
2	IO_L53P_2	K4	
2	IO_L54N_2	N4	
2	IO_L54P_2	M4	
2	IO_L67N_2	M2	
2	IO_L67P_2	L2	
2	IO_L68N_2	N8	
2	IO_L68P_2	P8	
2	IO_L69N_2	N6	
2	IO_L69P_2/VREF_2	P6	
2	IO_L70N_2	P5	
2	IO_L70P_2	N5	
2	IO_L71N_2	P10	
2	IO_L71P_2	R10	
2	IO_L72N_2	P3	
2	IO_L72P_2	N3	
2	IO_L73N_2	M1	
2	IO_L73P_2	L1	
2	IO_L74N_2	P9	
2	IO_L74P_2	R9	
2	IO_L75N_2	P2	
2	IO_L75P_2/VREF_2	N2	
2	IO_L76N_2	R4	
2	IO_L76P_2	P4	
2	IO_L77N_2	R8	
2	IO_L77P_2	T8	
2	IO_L78N_2	T3	
2	IO_L78P_2	R3	
2	IO_L79N_2	P1	NC
2	IO_L79P_2	N1	NC
2	IO_L80N_2	T11	NC
2	IO_L80P_2	U11	NC

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	VCCO_5	AP19	
5	VCCO_5	AL28	
5	VCCO_5	AK20	
5	VCCO_5	AD23	
5	VCCO_5	AD22	
5	VCCO_5	AD21	
5	VCCO_5	AD20	
5	VCCO_5	AC22	
5	VCCO_5	AC21	
5	VCCO_5	AC20	
5	VCCO_5	AC19	
5	VCCO_5	AC18	
6	VCCO_6	AH31	
6	VCCO_6	AE34	
6	VCCO_6	AC24	
6	VCCO_6	AB24	
6	VCCO_6	AB23	
6	VCCO_6	AA24	
6	VCCO_6	AA23	
6	VCCO_6	Y30	
6	VCCO_6	Y24	
6	VCCO_6	Y23	
6	VCCO_6	W34	
6	VCCO_6	W23	
6	VCCO_6	V23	
7	VCCO_7	U23	
7	VCCO_7	T34	
7	VCCO_7	T23	
7	VCCO_7	R30	
7	VCCO_7	R24	
7	VCCO_7	R23	
7	VCCO_7	P24	
7	VCCO_7	P23	
7	VCCO_7	N24	
7	VCCO_7	N23	
7	VCCO_7	M24	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	D4		
NA	GND	C39		
NA	GND	C38		
NA	GND	C37		
NA	GND	C3		
NA	GND	C2		
NA	GND	C1		
NA	GND	B39		
NA	GND	B38		
NA	GND	B37		
NA	GND	B29		
NA	GND	B11		
NA	GND	B3		
NA	GND	B2		
NA	GND	B1		
NA	GND	A38		
NA	GND	A37		
NA	GND	A20		
NA	GND	A3		
NA	GND	A2		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.